

## Sotomayor, John

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**From:** PLUS [PLUS2@uspto.gov]  
**Sent:** Friday, May 11, 2007 1:01 PM  
**To:** Sotomayor, John  
**Subject:** PLUS Results for serial number: 10555651



10555651\_WDS.  
txt



10555651\_LIST.  
txt



10555651\_WES  
T.txt



10555651\_CLST  
ITLES.txt



10555651\_QUAL  
.txt



10555651\_EAST  
.txt



10555651\_CLS.t  
xt



10555651\_result  
s.east

Thanks for using the PLUS system. Your results are attached. You can also view and download them at <http://mars:9000/plus/user/downloadresults.jsf?rqstId=44816&serialNumber=10555651>

This search was prepared by the staff of the Scientific and Technical Information Center, SIRA. If you have questions or comments about this search, please reply via email to PLUS@uspto.gov

# SEARCH NOTES FOR EAST, IEEE, INSPEC, IP.COM, AND PROQUEST

**SERIAL NUMBER**

10555651

## EAST SEARCH

EAST: search history attached  
Search terms:

semiconductor same (package or device or assembly) same multilayer same dielectric same substrate

bias same control

ground same conductor

ground same via

resistance same film same surface

electromagnetic same (shield or shielded or shielding)

(semiconductor and (package or device or assembly) and multilayer and dielectric and substrate and bias and control and ground and conductor and ground and via and resistance and film and surface and electromagnetic and (shield or shielded or shielding)).clm.

## IEEE SEARCH

Sun, 16 Sep 2007, 6:35:44 PM EST

Recent Search Queries

Results

#1 ((semiconductor and (package or device or assembly) and multilayer and dielectric and substrate and bias and control and ground and conductor and ground and via and resistance and film and surface and electromagnetic and (shield or shielded or shielding))<in>metadata)

0

## INSPEC SEARCH

Search history:

No.	Database	Search term	Info added since	Results	
CP		[Clipboard]		0	-
1	INZZ	semiconductor AND (package OR device OR assembly) AND multilayer AND dielectric AND substrate AND bias AND control AND ground AND conductor AND ground AND via AND resistance AND film AND surface AND electromagnetic AND (shield OR shielded OR shielding)	unrestricted	0	

- Search by
- DB: SUS-PCPU8  ☒ Highlight all hit terms initially
- Default generator: [OR]
- (semiconductor and (package or device or assembly) and multilayer and dielectric and substrate and bias and control and ground and conductor and ground and via and resistance and film and surface and electromagnetic and (shield or shielded or shielding)).clm

	Search Terms	Total	USPAT	US PGP INT	EPO	JPO	Derwa
1	ASSEMBLES	103901					
2	ASSEMBLY	373759					
3	ASSEMBLYS	49					
4	BIA	1847					
5	BIAS	111655					
6	BIUM	7					
7	BIUMS	0					
8	CONDUCTOR	87584					
9	CONDUCTOR	57609					

PGPUB-DOCUMENT- 20070040735  
NUMBER:  
PGPUB-FILING-  
TYPE:  
DOCUMENT- US 20070040735 A1  
IDENTIFIER:  
TITLE: High frequency package, transmitting and  
receiving module and wireless equipment  
PUBLICATION- February 22, 2007

## **IP.COM SEARCH**

semiconductor and (package or device or assembly) and multilayer and dielectric and substrate and bias and control and ground and conductor and ground and via and resistance and film and surface and electromagnetic and (shield or shielded or shielding)

**No records matched your search.**

## **PROQUEST SEARCH**

(semiconductor and (package or device or assembly) and multilayer and dielectric and substrate and bias and control and ground and conductor and ground and via and resistance and film and surface and electromagnetic and (shield or shielded or shielding)).clm.

No relevant documents found.